Ordering number : ENA1531A

SANYO Semiconductors

DATA SHEET

An ON Semiconductor Company

P-Channel Silicon MOSFET

SCH1333 — General-Purpose Switching Device Applications

Features

- 1.8V drive
- Halogen free compliance
- Protection diode in

Specifications

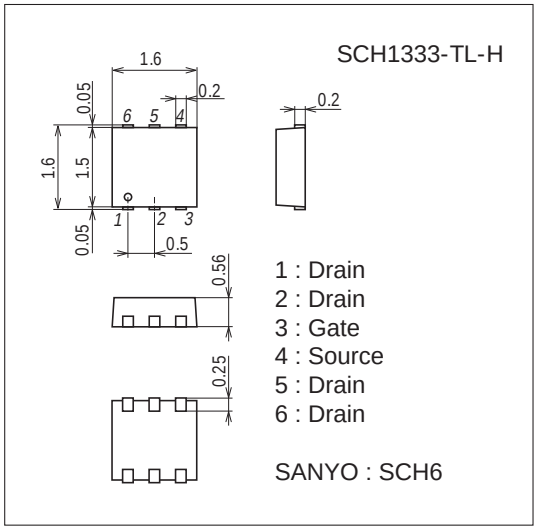
Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V_{DSS}		−20	V
Gate-to-Source Voltage	V_{GSS}		±10	V
Drain Current (DC)	I_D		−2	A
Drain Current (Pulse)	I_{DP}	PW≤10μs, duty cycle≤1%	−8	A
Allowable Power Dissipation	P_D	When mounted on ceramic substrate (900mm²×0.8mm)	0.8	W
Channel Temperature	Tch		150	℃
Storage Temperature	Tstg		−55 to +150	℃

Package Dimensions

unit : mm (typ)

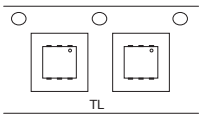
7028-002



Product & Package Information

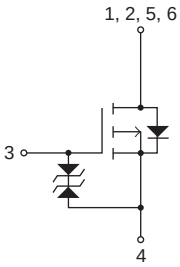
- Package : SCH6
- JEITA, JEDEC : SOT-563
- Minimum Packing Quantity : 5,000 pcs./reel

Packing Type : TL



Marking

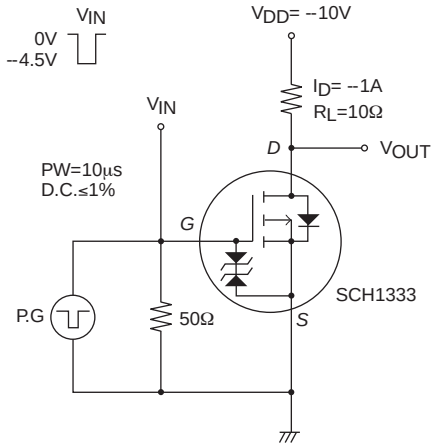
Electrical Connection



Electrical Characteristics at Ta=25°C

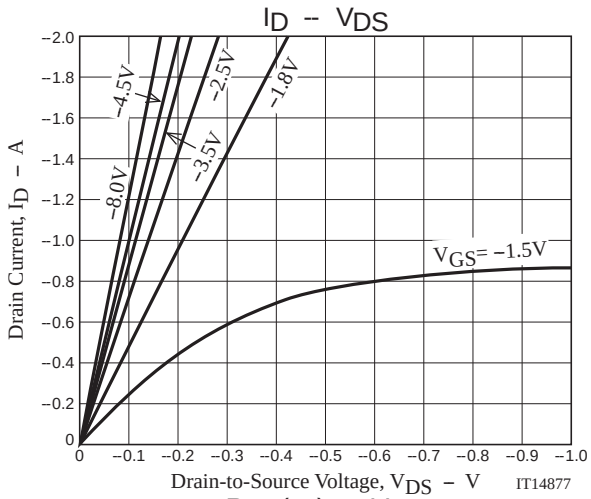
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	I_D=−1mA, V_{GS}=0V	−20			V
Zero-Gate Voltage Drain Current	I_{DSS}	V_{DS}=−20V, V_{GS}=0V			−1	μA
Gate-to-Source Leakage Current	I_{GSS}	V_{GS}=±8V, V_{DS}=0V			±10	μA
Cutoff Voltage	V_{GS}(off)	V_{DS}=−10V, I_D=−1mA	−0.4		−1.4	V
Forward Transfer Admittance	| yfs |	V_{DS}=−10V, I_D=−1A		2.7		S
Static Drain-to-Source On-State Resistance	R_{DS}(on)1	I_D=−1A, V_{GS}=−4.5V		100	130	mΩ
	R_{DS}(on)2	I_D=−0.5A, V_{GS}=−2.5V		140	196	mΩ
	R_{DS}(on)3	I_D=−0.1A, V_{GS}=−1.8V		210	315	mΩ
Input Capacitance	Ciss	V_{DS}=−10V, f=1MHz		250		pF
Output Capacitance	Coss			60		pF
Reverse Transfer Capacitance	Crss			45		pF
Turn-ON Delay Time	t_d(on)	See specified Test Circuit.		5.7		ns
Rise Time	t_r			11		ns
Turn-OFF Delay Time	t_d(off)			34		ns
Fall Time	t_f			20		ns
Total Gate Charge	Qg	V_{DS}=−10V, V_{GS}=−4.5V, I_D=−2A		3.3		nC
Gate-to-Source Charge	Qgs			0.65		nC
Gate-to-Drain “Miller” Charge	Qgd			0.72		nC
Diode Forward Voltage	V_{SD}	I_S=−2A, V_{GS}=0V		−0.85	−1.2	V

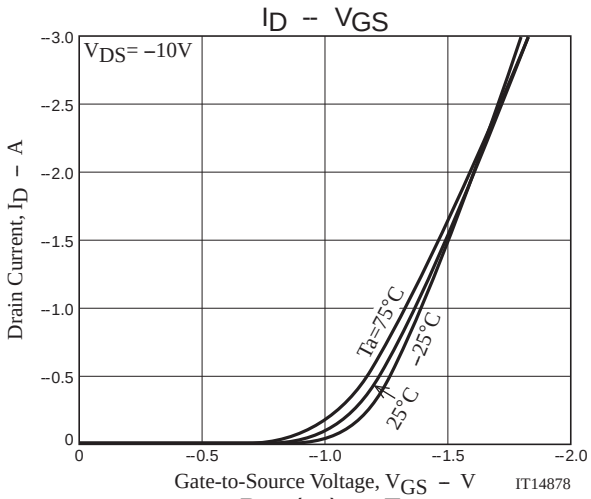
Switching Time Test Circuit

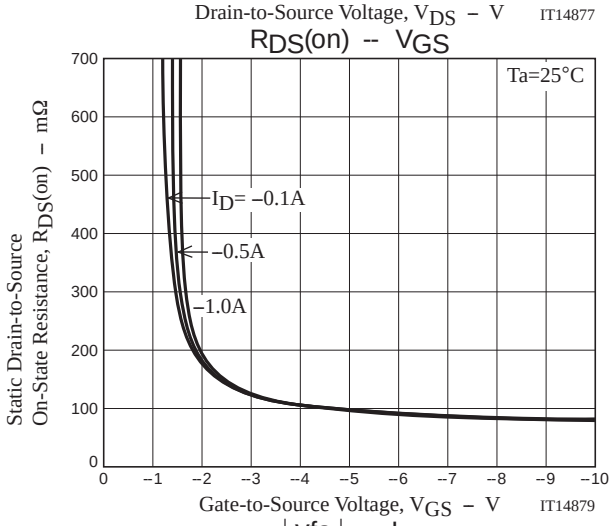


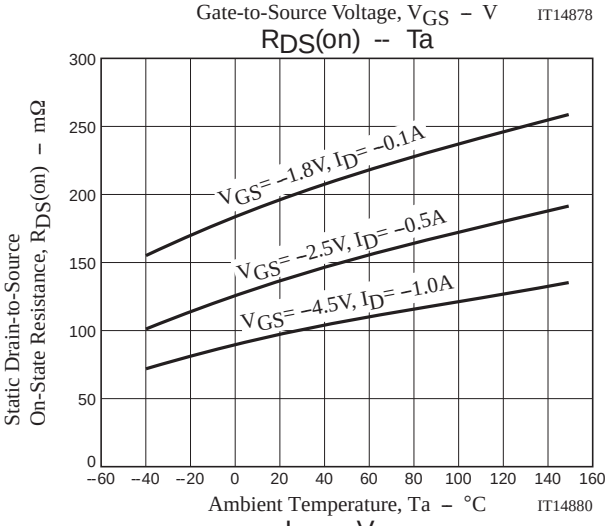
Ordering Information

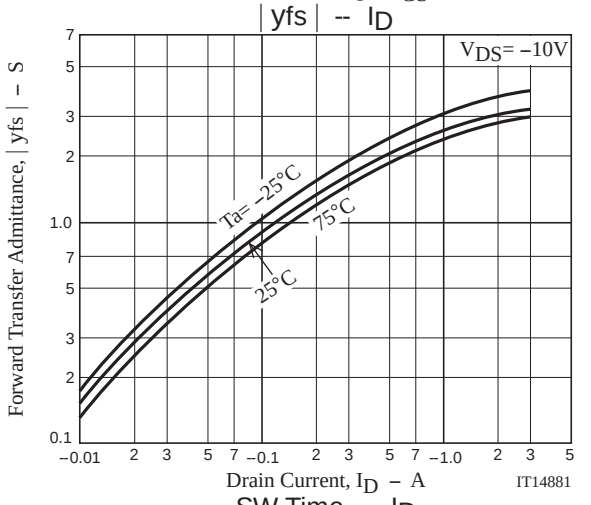
Device	Package	Shipping	memo
SCH1333-TL-H	SCH6	5,000pcs./reel	Pb Free and Halogen Free

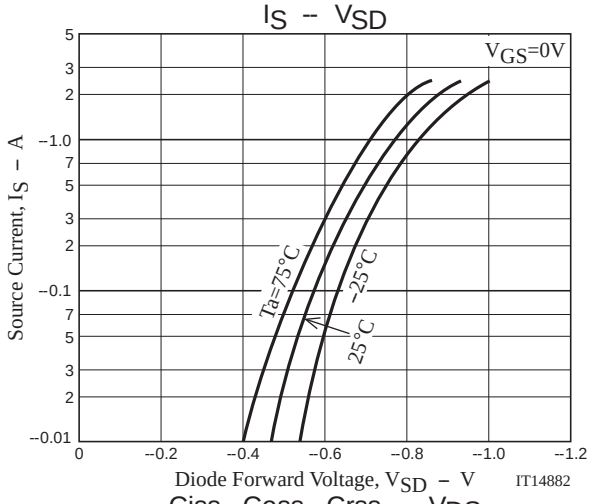

ID -- VDS
Drain Current, ID – A
Drain-to-Source Voltage, VDS – V
IT14877
–4.5V
–2.5V
–1.8V
–8.0V
–3.5V
VGS= –1.5V

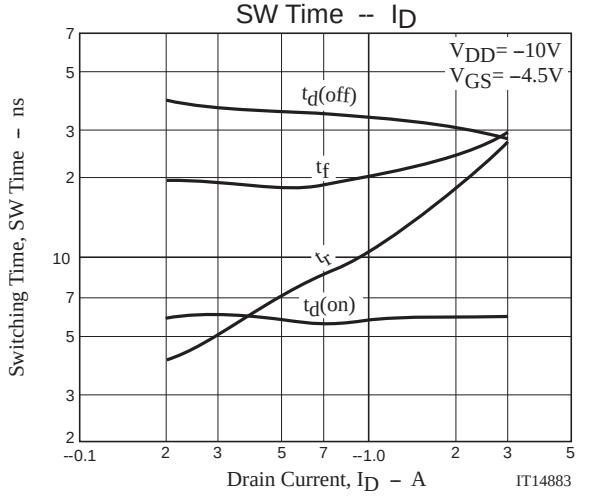

ID -- VGS
VDS= –10V
Drain Current, ID – A
Gate-to-Source Voltage, VGS – V
IT14878
Ta=75°C
–25°C
25°C

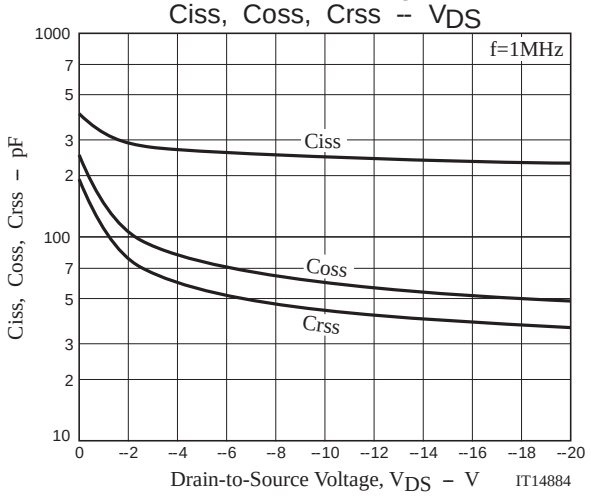

RDS(on) -- VGS
Ta=25°C
Static Drain-to-Source
On-State Resistance, RDS(on) – mΩ
Gate-to-Source Voltage, VGS – V
IT14879
ID= –0.1A
–0.5A
–1.0A

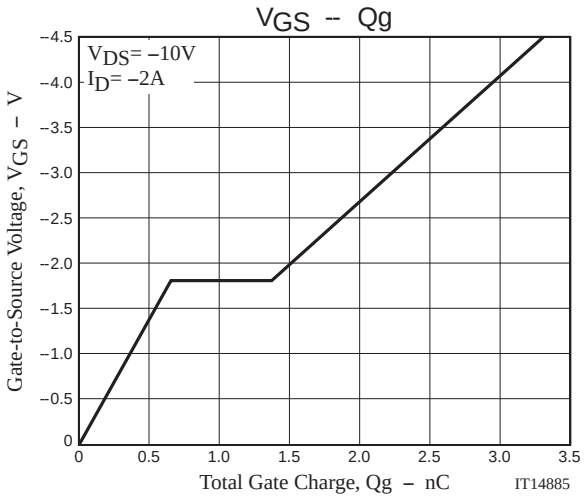

RDS(on) -- Ta
Static Drain-to-Source
On-State Resistance, RDS(on) – mΩ
Ambient Temperature, Ta – °C
IT14880
VGS= –1.8V, ID= –0.1A
VGS= –2.5V, ID= –0.5A
VGS= –4.5V, ID= –1.0A

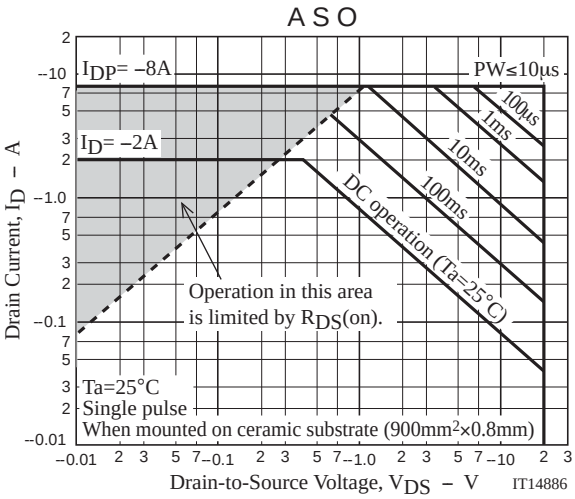

| yfs | -- ID
VDS= –10V
Forward Transfer Admittance, | yfs | – S
Drain Current, ID – A
IT14881
Ta= –25°C
75°C
25°C

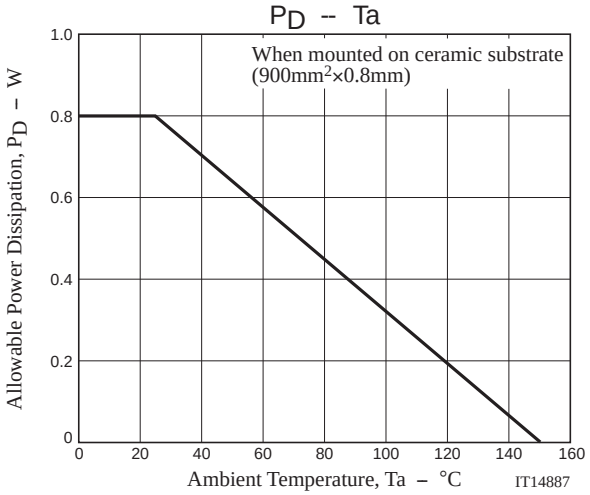

IS -- VSD
VGS=0V
Source Current, IS – A
Diode Forward Voltage, VSD – V
IT14882
Ta=75°C
–25°C
25°C


SW Time -- ID
VDD= –10V
VGS= –4.5V
Switching Time, SW Time – ns
Drain Current, ID – A
IT14883
td(off)
tf
tr
td(on)


Ciss, Coss, Crss -- VDS
f=1MHz
Ciss, Coss, Crss – pF
Drain-to-Source Voltage, VDS – V
IT14884
Ciss
Coss
Crss


VGS -- Qg
VDS= −10V
ID= −2A
Gate-to-Source Voltage, VGS – V
Total Gate Charge, Qg – nC
IT14885


A S O
IDP= −8A
PW≤10μs
100μs
1ms
10ms
100ms
DC operation (Ta=25°C)
ID= −2A
Operation in this area
is limited by RDS(on).
Ta=25°C
Single pulse
When mounted on ceramic substrate (900mm2×0.8mm)
Drain Current, ID – A
Drain-to-Source Voltage, VDS – V
IT14886


PD -- Ta
When mounted on ceramic substrate
(900mm2×0.8mm)
Allowable Power Dissipation, PD – W
Ambient Temperature, Ta – °C
IT14887

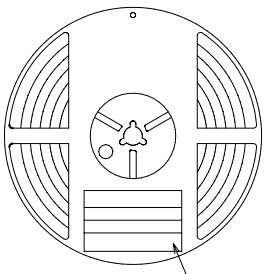
Taping Specification

SCH1333-TL-H

1. Packing Format

Package Name	Carrier Tape Type	Maximum Number of devices contained (pcs)			Packing format	
		Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)
SCH6	SCH6	5,000	25,000	150,000	5 reels contained Dimensions:mm(external) 183×72×185	6 inner boxes contained Dimensions:mm(external) 440×195×210

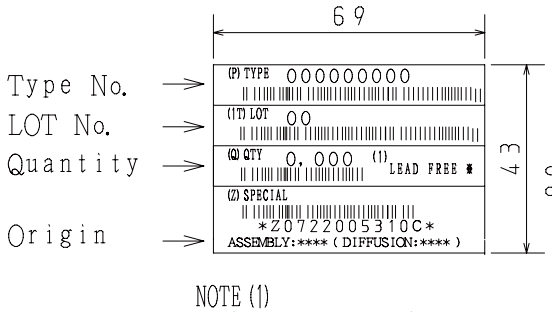
Packing method



Reel label

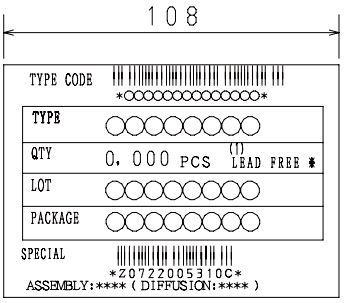
Reel label, Inner box label

(unit:mm)



Outer box label

It is a label at the time of factory shipments. The form of a label may change in physical distribution process.

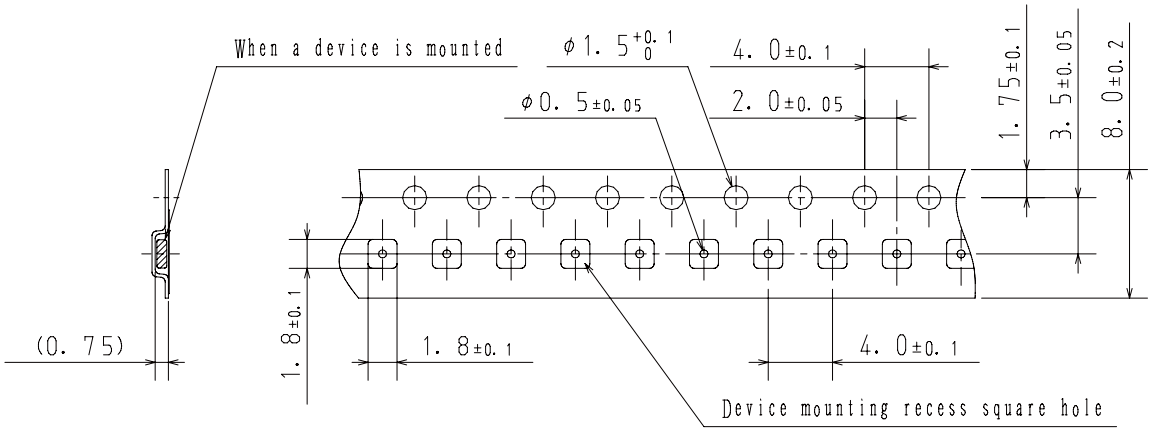


NOTE (1)
The LEAD FREE ※ description shows that the surface treatment of the terminal is lead free.

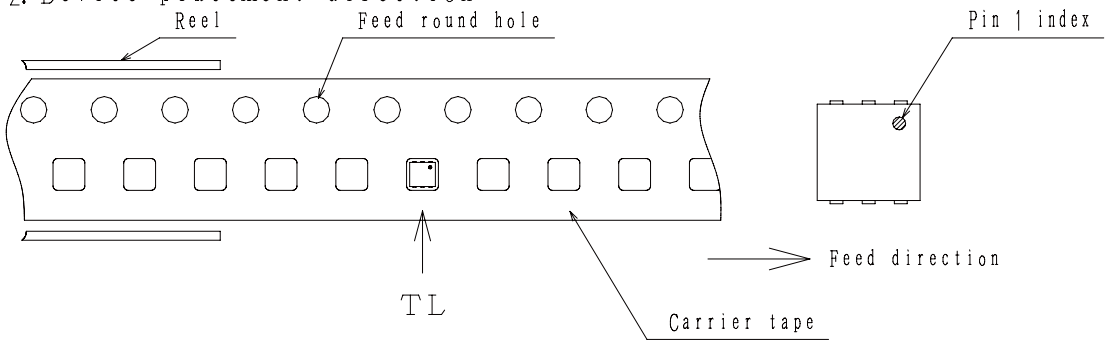
Label	JEITA Phase
LEAD FREE 3	JEITA Phase 3A
LEAD FREE 4	JEITA Phase 3

2. Taping configuration

2-1. Carrier tape size (unit:mm)



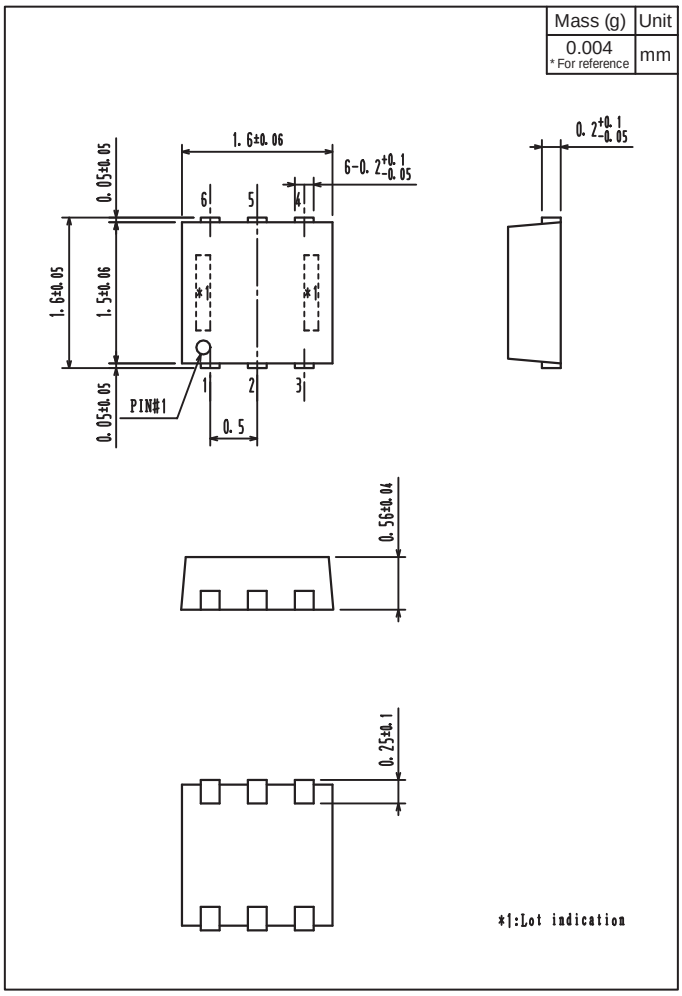
2-2. Device placement direction



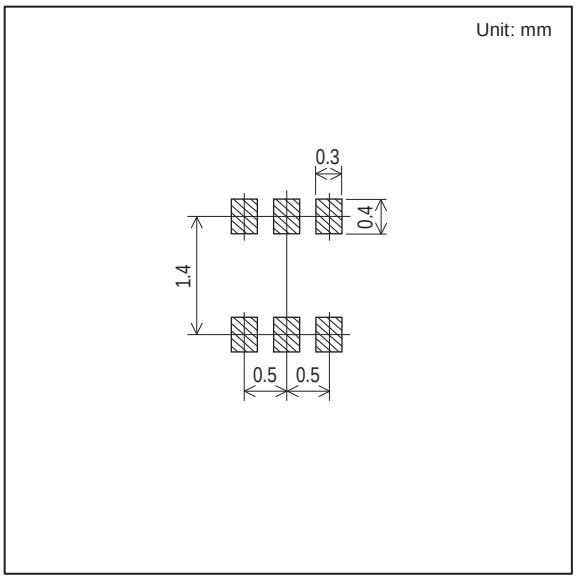
Those with pin 1 index on the feed hole side·····TL

Outline Drawing

SCH1333-TL-H



Land Pattern Example



Note on usage : Since the SCH1333 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

This catalog provides information as of June, 2012. Specifications and information herein are subject to change without notice.